High-Power NPN Silicon Transistors

... designed for use in industrial-military power amplifier and switching circuit applications.

• High Collector-Emitter Sustaining Voltage -

VCEO(sus) = 100 Vdc (Min) — 2N6338

= 120 Vdc (Min) — 2N6339

= 140 Vdc (Min) - 2N6340

= 150 Vdc (Min) — 2N6341

• High DC Current Gain -

h_{FF} = 30 - 120 @ I_C = 10 Adc

= 12 (Min) @ IC = 25 Adc

• Low Collector-Emitter Saturation Voltage —

VCE(sat) = 1.0 Vdc (Max) @ IC = 10 Adc

Fast Switching Times @ I_C = 10 Adc

 $t_r = 0.3 \, \mu s \, (Max)$

 $t_{S} = 1.0 \,\mu s \,(Max)$

 $t_f = 0.25 \,\mu s \,(Max)$

• Complement to 2N6436-38

*MAXIMUM RATINGS

Rating	Symbol	2N6338	2N6339	2N6340	2N6341	Unit
Collector-Base Voltage	VCB	120	140	160	180	Vdc
Collector–Emitter Voltage	VCEO	100	120	140	150	Vdc
Emitter-Base Voltage	VEB	6.0			Vdc	
Collector Current Continuous Peak	IC	25 50			Adc	
Base Current	ΙΒ	10			Adc	
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	200 1.14		Watts W/°C		
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200			°C	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit	
Thermal Resistance, Junction to Case	θJC	0.875	°C/W	

^{*} Indicates JEDEC Registered Data.

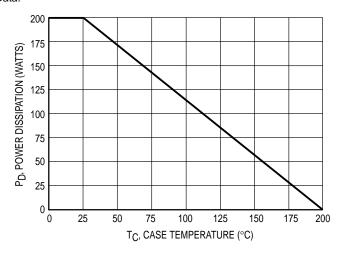


Figure 1. Power Derating

Preferred devices are Motorola recommended choices for future use and best overall value.

REV 7

2N6338 2N6339 2N6340 2N6341*

*Motorola Preferred Device

25 AMPERE
POWER TRANSISTORS
NPN SILICON
100, 120, 140, 150 VOLTS
200 WATTS



CASE 1-07 TO-204AA (TO-3)



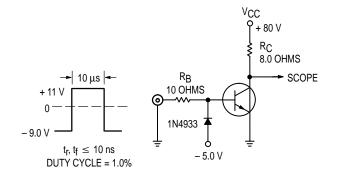
2N6338 2N6339 2N6340 2N6341

*ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (1) (I _C = 50 mAdc, I _B = 0)	2N6338 2N6339 2N6340 2N6341	VCEO(sus)	100 120 140 150	_ _ _ _	Vdc
Collector Cutoff Current (V _{CE} = 50 Vdc, I _B = 0) (V _{CE} = 60 Vdc, I _B = 0) (V _{CE} = 70 Vdc, I _B = 0) (V _{CE} = 75 Vdc, I _B = 0)	2N6338 2N6339 2N6340 2N6341	ICEO		50 50 50 50	μAdc
Collector Cutoff Current (V _{CE} = Rated V _{CEO} , V _{EB(off)} = 1.5 Vdc) (V _{CE} = Rated V _{CEO} , V _{EB(off)} = 1.5 Vdc, T _C = 150°C)		ICEX	_	10 1.0	μAdc mAdc
Collector Cutoff Current (V _{CB} = Rated V _{CB} , I _E = 0)		ICBO	_	10	μAdc
Emitter Cutoff Current (VBE = 6.0 Vdc, IC = 0)		IEBO		100	μAdc
ON CHARACTERISTICS (1)					
DC Current Gain) $(I_{C} = 0.5 \text{ Adc}, V_{CE} = 2.0 \text{ Vdc})$ $(I_{C} = 10 \text{ Adc}, V_{CE} = 2.0 \text{ Vdc})$ $(I_{C} = 25 \text{ Adc}, V_{CE} = 2.0 \text{ Vdc})$		hFE	50 30 12	_ 120 _	_
Collector Emitter Saturation Voltage (I _C = 10 Adc, I _B = 1.0 Adc) (I _C = 25 Adc, I _B = 2.5 Adc)		VCE(sat)	_ _	1.0 1.8	Vdc
Base–Emitter Saturation Voltage (I _C = 10 Adc, I _B = 1.0 Adc) (I _C = 25 Adc, I _B = 2.5 Adc)		VBE(sat)	_ _	1.8 2.5	Vdc
Base–Emitter On Voltage (I _C = 10 Adc, V _{CE} = 2.0 Vdc)		V _{BE(on)}	_	1.8	Vdc
DYNAMIC CHARACTERISTICS					
Current–Gain — Bandwidth Product (2) (I _C = 1.0 Adc, V _{CE} = 10 Vdc, f _{test} = 10 MHz)			40	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)				300	pF
SWITCHING CHARACTERISTICS					
Rise Time ($V_{CC} \approx 80 \text{ Vdc}$, $I_{C} = 10 \text{Adc}$, $I_{B1} = 1.0 \text{ Adc}$, $V_{BE(off)} = 6.0 \text{ Vdc}$)				0.3	μs
Storage Time ($V_{CC} \approx 80 \text{ Vdc}$, $I_C = 10 \text{ Adc}$, $I_{B1} = I_{B2} = 1.0 \text{ Adc}$)	t _S	_	1.0	μs	
Fall Time ($V_{CC} \approx 80 \text{ Vdc}$, $I_C = 10 \text{ Adc}$, $I_{B1} = I_{B2} = 1.0 \text{ Adc}$)				0.25	μs

^{*} Indicates JEDEC Registered Data.

⁽²⁾ $f_T = |h_{fe}| \cdot f_{test}$.



NOTE: For information on Figures 3 and 6, R_B and R_C were varied to obtain desired test conditions.

Figure 2. Switching Time Test Circuit

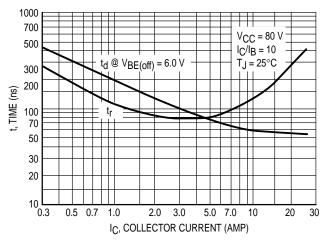


Figure 3. Turn-On Time

⁽¹⁾ Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

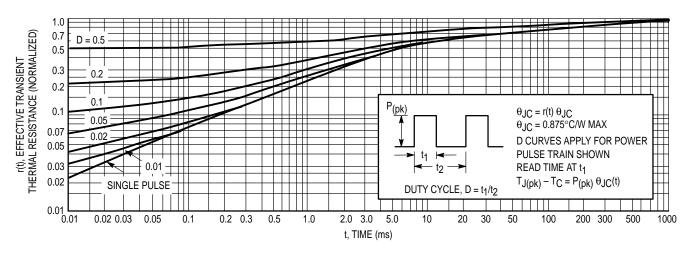


Figure 4. Thermal Response

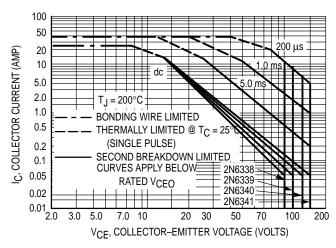


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C–V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 200^{\circ}C$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 200^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

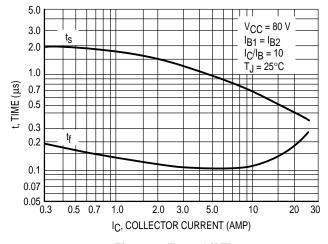


Figure 6. Turn-Off Time

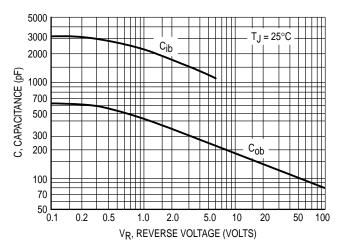
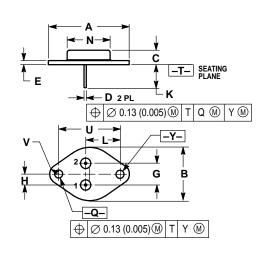


Figure 7. Capacitance

PACKAGE DIMENSIONS



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
 VALUE MARKET AND TOLERANCING PER AND TOLERANCING PE
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
- ALL RULES AND NOTES ASSOCIATED WITH
 REFERENCED TO-204AA OUTLINE SHALL APPLY.

	INCHES		MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	1.550 REF		39.37 REF			
В		1.050		26.67		
С	0.250	0.335	6.35	8.51		
D	0.038	0.043	0.97	1.09		
E	0.055	0.070	1.40	1.77		
G	0.430 BSC		10.92 BSC			
Н	0.215	0.215 BSC		5.46 BSC		
K	0.440	0.480	11.18	12.19		
L	0.665	BSC	16.89	BSC		
N		0.830		21.08		
Q	0.151	0.165	3.84	4.19		
U	1.187	BSC	30.15 BSC			
٧	0.131	0.188	3.33	4.77		

STYLE 1:
PIN 1. BASE
2. EMITTER
CASE: COLLECTOR

CASE 1-07 TO-204AA (TO-3) ISSUE Z

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